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Docket No.: 4448-0173P  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Chen-Jung TSAI et al.

Application No.: 10/726,577

Confirmation No.: 5109

Filed: December 4, 2003

Art Unit: 2815

For: DUAL CHIPS STACKED PACKAGING  
STRUCTURE

Examiner: J. A. Fenty

**PRELIMINARY AMENDMENT**

MS RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**INTRODUCTORY COMMENTS**

In reply to the Final Office Action dated September 19, 2005, and in view of the Request for Continued Examination (RCE) being submitted concurrently herewith, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

This reply includes:

Amendments to the Claims; and

Remarks.